

### General Description

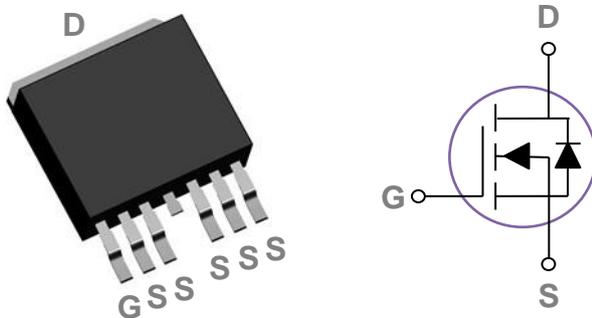
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BVDSS	RDSON	ID
40V	0.65mΩ	300A

### Features

- 40V,300A,  $R_{DS(ON)} = 0.65m\Omega @ V_{GS} = 10V$
- Improved  $dv/dt$  capability
- Fast switching
- Green Device Available

### TO263-6L Pin Configuration



### Applications

- Motor Driver
- Load Switch
- Power Tools

### Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	40	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Drain Current – Continuous ( $T_c=25^\circ\text{C}$ )	300	A
	Drain Current – Continuous ( $T_c=100^\circ\text{C}$ )	192	A
$I_{DM}$	Drain Current – Pulsed <sup>1</sup>	1200	A
EAS	Single Pulse Avalanche Energy <sup>2</sup>	1414	mJ
IAS	Single Pulse Avalanche Current <sup>2</sup>	168	A
$P_D$	Power Dissipation ( $T_c=25^\circ\text{C}$ )	347	W
	Power Dissipation – Derate above $25^\circ\text{C}$	2.78	W/ $^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
$T_J$	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$

### Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	62	$^\circ\text{C}/\text{W}$
$R_{\theta JC}$	Thermal Resistance Junction to Case	---	0.36	$^\circ\text{C}/\text{W}$

**Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)**
**Off Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	40	---	---	V
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=40V, V_{GS}=0V, T_J=25^\circ\text{C}$	---	---	1	$\mu A$
		$V_{DS}=32V, V_{GS}=0V, T_J=85^\circ\text{C}$	---	---	10	$\mu A$
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	---	---	$\pm 100$	nA

**On Characteristics**

$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10V, I_D=20A$	---	0.55	0.65	m $\Omega$
		$V_{GS}=4.5V, I_D=10A$	---	0.77	1	m $\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\mu A$	1.2	1.6	2.5	V

**Dynamic and switching Characteristics<sup>3</sup>**

$Q_g$	Total Gate Charge	$V_{DS}=20V, V_{GS}=10V, I_D=80A$	---	210	315	nC
			---	110	165	
$Q_{gs}$	Gate-Source Charge	$V_{DS}=20V, V_{GS}=4.5V, I_D=80A$	---	19	30	
$Q_{gd}$	Gate-Drain Charge		---	50	75	
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}=20V, V_{GS}=10V, R_G=6\Omega, I_D=80A$	---	30	45	ns
$T_r$	Rise Time		---	40	60	
$T_{d(off)}$	Turn-Off Delay Time		---	80	120	
$T_f$	Fall Time		---	110	165	
$C_{iss}$	Input Capacitance	$V_{DS}=20V, V_{GS}=0V, F=1\text{MHz}$	---	9750	15000	pF
$C_{oss}$	Output Capacitance		---	3700	5600	
$C_{riss}$	Reverse Transfer Capacitance		---	500	750	
$R_g$	Gate resistance	$V_{GS}=0V, V_{DS}=0V, F=1\text{MHz}$	---	1	---	$\Omega$

**Guaranteed Avalanche Energy**

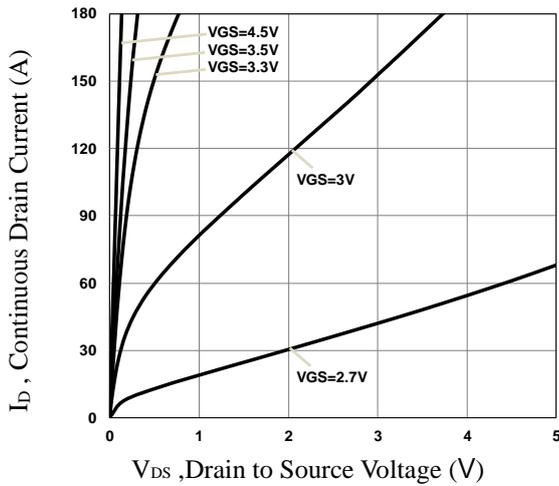
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
EAS	Single Pulse Avalanche Energy	$V_{DD}=25V, L=0.1\text{mH}, I_{AS}=100A$	500	---	---	mJ

**Drain-Source Diode Characteristics and Maximum Ratings**

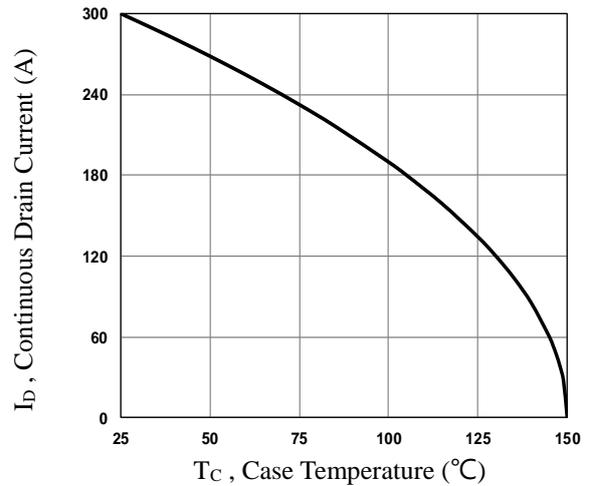
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_S$	Continuous Source Current	$V_G=V_D=0V, \text{Force Current}$	---	---	300	A
$I_{SM}$	Pulsed Source Current		---	---	600	A
$V_{SD}$	Diode Forward Voltage	$V_{GS}=0V, I_S=1A, T_J=25^\circ\text{C}$	---	---	1	V
$t_{rr}$	Reverse Recovery Time	$V_R=30V, I_S=10A$	---	210	---	ns
$Q_{rr}$	Reverse Recovery Charge	$di/dt=100A/\mu s, T_J=25^\circ\text{C}$	---	750	---	nC

Note :

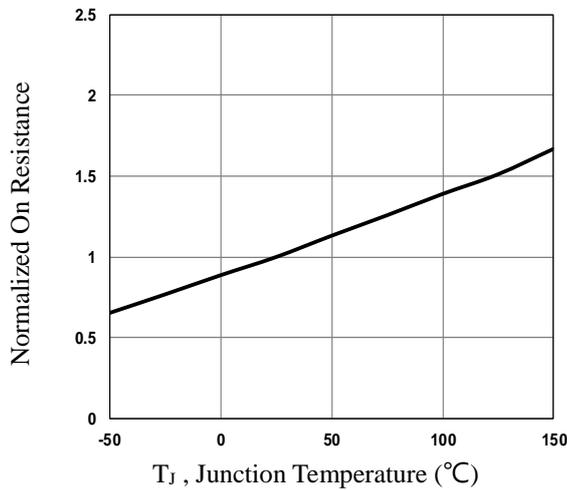
1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2.  $V_{DD}=25V, V_{GS}=10V, L=0.1\text{mH}, I_{AS}=168A, R_G=25\Omega, \text{Starting } T_J=25^\circ\text{C}.$
3. Essentially independent of operating temperature.



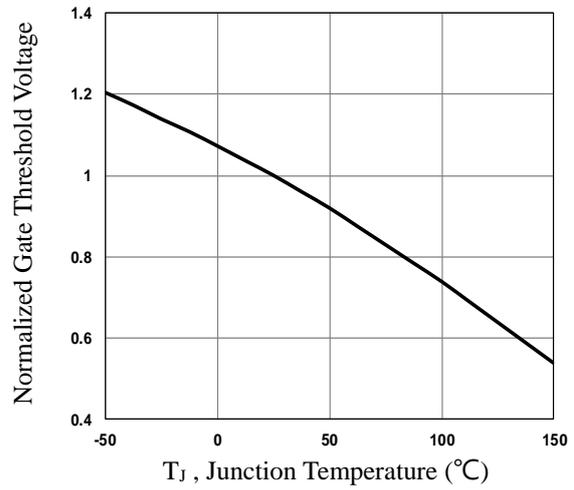
**Fig.1 Typical Output Characteristics**



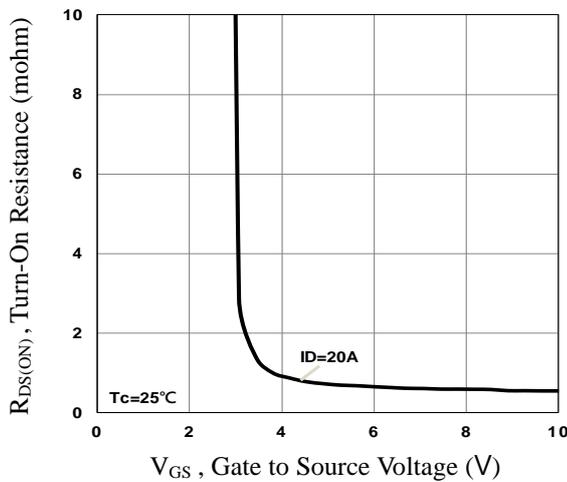
**Fig.2 Continuous Drain Current vs. T<sub>c</sub>**



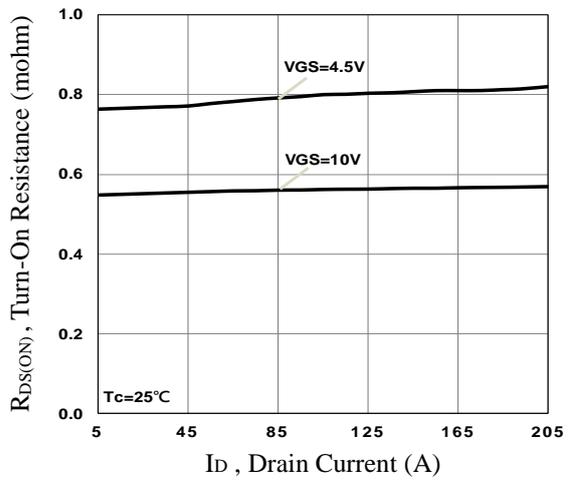
**Fig.3 Normalized R<sub>DS(on)</sub> vs. T<sub>j</sub>**



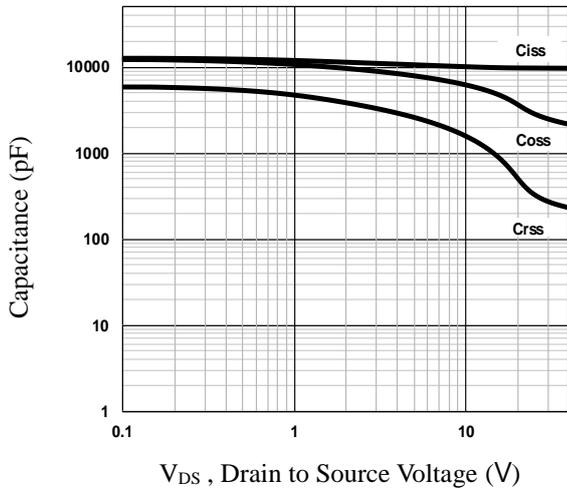
**Fig.4 Normalized V<sub>th</sub> vs. T<sub>j</sub>**



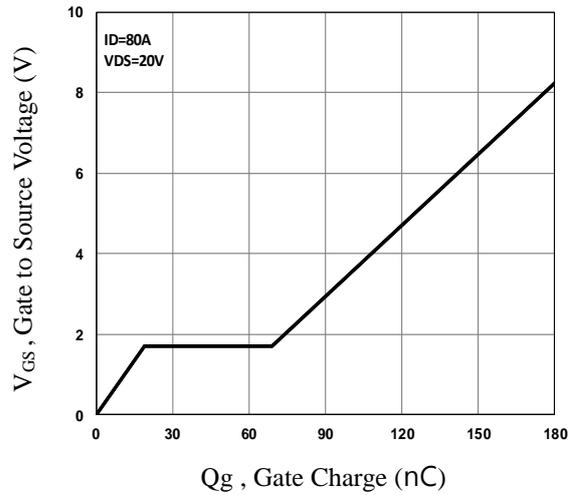
**Fig.5 Turn-On Resistance vs. V<sub>GS</sub>**



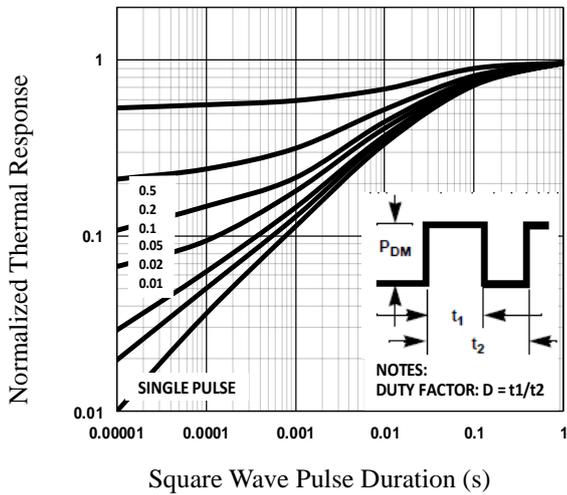
**Fig.6 Turn-On Resistance vs. I<sub>D</sub>**



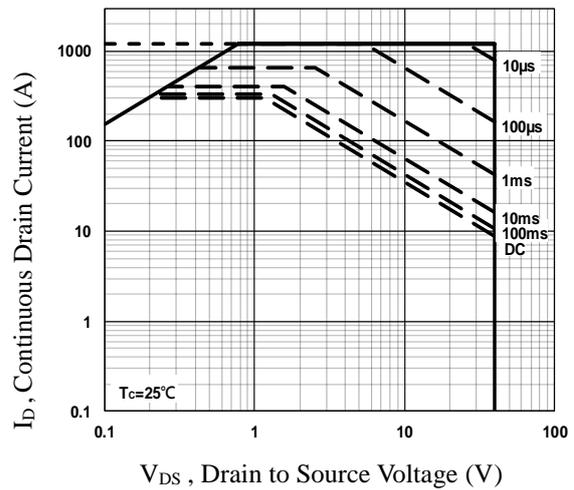
**Fig.7 Capacitance Characteristics**



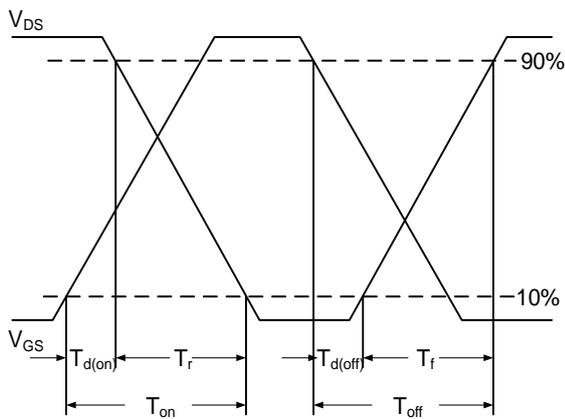
**Fig.8 Gate Charge Characteristics**



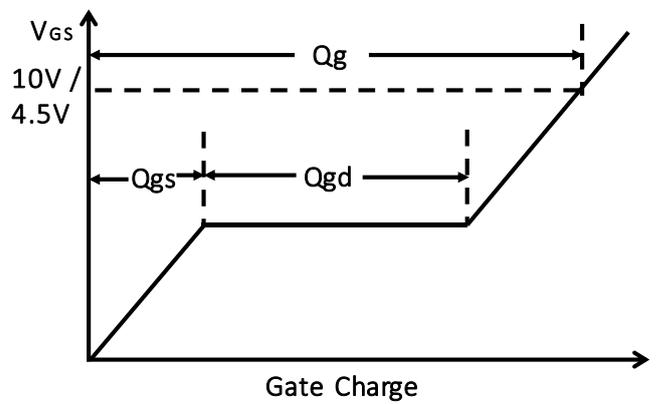
**Fig.9 Normalized Transient Impedance**



**Fig.10 Maximum Safe Operation Area**

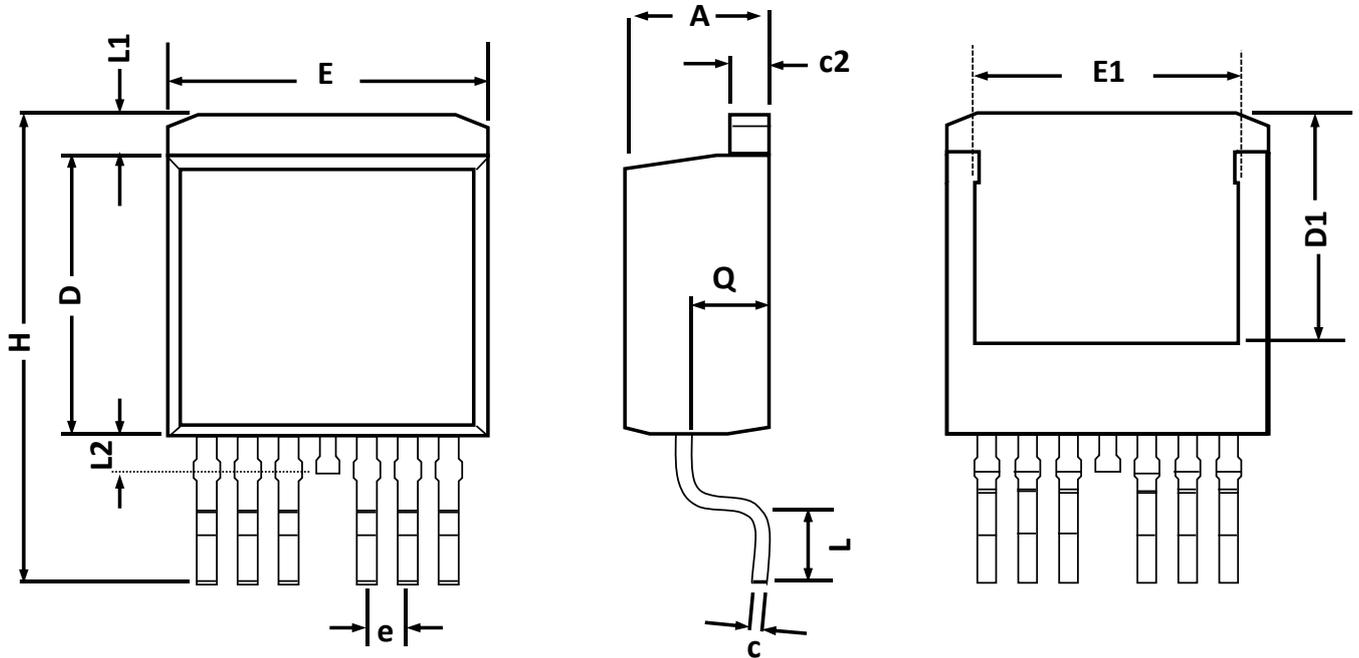


**Fig.11 Switching Time Waveform**



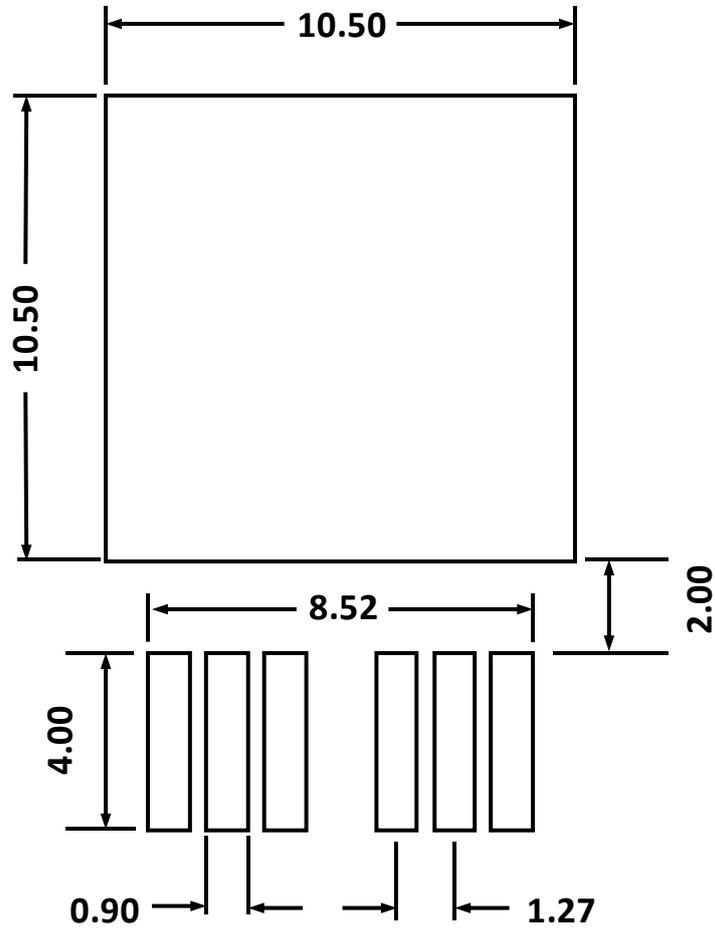
**Fig.12 Gate Charge Waveform**

TO263-6L PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Max	Min	Max	Min
A	4.650	4.200	0.183	0.165
b	0.700	0.500	0.028	0.020
c	0.600	0.400	0.024	0.016
c2	1.400	1.150	0.055	0.045
D	9.050	8.800	0.356	0.346
D1	---	6.850	---	0.270
E	10.400	9.950	0.409	0.392
E1	8.550	8.150	0.337	0.321
e	1.270 BSC		0.050 BSC	
H	15.900	14.600	0.626	0.575
L	2.800	1.750	0.110	0.069
L1	1.360 REF.		0.054 REF.	
L2	1.200 REF.		0.047 REF.	
Q	2.700	2.300	0.106	0.091

### TO263-6L RECOMMENDED LAND PATTERN



unit : mm